

# MOS FIELD EFFECT TRANSISTOR 2SJ673

# SWITCHING P-CHANNEL POWER MOS FET

#### **DESCRIPTION**

The 2SJ673 is P-channel MOS Field Effect Transistor designed for high current switching applications.

#### ORDERING INFORMATION

PART NUMBER	PACKAGE
2SJ673	Isolated TO-220 (MP-45F)

#### **FEATURES**

• Super low on-state resistance

 $R_{DS(on)1}$  = 20  $m\Omega$  MAX. (VGS = -10 V, ID = -18 A)

 $R_{DS(on)2} = 31 \text{ m}\Omega \text{ MAX.} (V_{GS} = -4.0 \text{ V}, I_{D} = -18 \text{ A})$ 

- Low Ciss: Ciss = 4600 pF TYP.
- Built-in gate protection diode

(Isolated TO-220)



#### ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (V <sub>GS</sub> = 0 V)	VDSS	-60	V
Gate to Source Voltage (V <sub>DS</sub> = 0 V)	Vgss	∓20	V
Drain Current (DC) (Tc = 25°C)	I <sub>D(DC)</sub>	∓36	Α
Drain Current (pulse) Note1	D(pulse)	<b>∓144</b>	Α
Total Power Dissipation (Tc = 25°C)	P <sub>T1</sub>	32	W
Total Power Dissipation (T <sub>A</sub> = 25°C)	P <sub>T2</sub>	2.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C
Single Avalanche Current Note2	las	-36	Α
Single Avalanche Energy Note2	Eas	130	mJ

**Notes 1.** PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1%

2. Starting T<sub>ch</sub> = 25°C, V<sub>DD</sub> = -30 V, R<sub>G</sub> = 25  $\Omega$ , V<sub>GS</sub> = 20  $\rightarrow$  0 V

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#### **ELECTRICAL CHARACTERISTICS (TA = 25°C)**

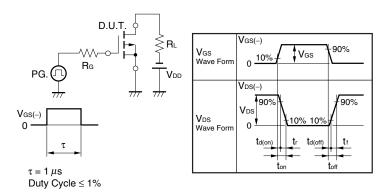
	•	•				
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> = -60 V, V <sub>GS</sub> = 0 V			-10	μΑ
Gate Leakage Current	Igss	V <sub>GS</sub> = ∓20 V, V <sub>DS</sub> = 0 V			∓10	μΑ
Gate Cut-off Voltage	V <sub>GS(off)</sub>	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -1 mA	-1.5	-2.0	-2.5	V
Forward Transfer Admittance Note	<b>y</b> fs	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -18 A	22			S
Drain to Source On-state Resistance Note	RDS(on)1	V <sub>GS</sub> = -10 V, I <sub>D</sub> = -18 A		17	20	mΩ
	RDS(on)2	V <sub>GS</sub> = -4.0 V, I <sub>D</sub> = -18 A		22	31	mΩ
Input Capacitance	Ciss	V <sub>DS</sub> = -10 V		4600		pF
Output Capacitance	Coss	V <sub>GS</sub> = 0 V		820		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		330		pF
Turn-on Delay Time	t <sub>d(on)</sub>	$V_{DD} = -30 \text{ V}, I_{D} = -18 \text{ A}$		14		ns
Rise Time	tr	V <sub>GS</sub> = -10 V		14		ns
Turn-off Delay Time	t <sub>d(off)</sub>	R <sub>G</sub> = 0 Ω		130		ns
Fall Time	t <sub>f</sub>			50		ns
Total Gate Charge	Q <sub>G</sub>	V <sub>DD</sub> = -48 V		87		nC
Gate to Source Charge	Qgs	V <sub>GS</sub> = -10 V		15		nC
Gate to Drain Charge	Q <sub>GD</sub>	I <sub>D</sub> = -36 A		22		nC
Body Diode Forward Voltage Note	V <sub>F(S-D)</sub>	I <sub>F</sub> = -36 A, V <sub>GS</sub> = 0 V		1.0		V
Reverse Recovery Time	trr	I <sub>F</sub> = -36 A, V <sub>GS</sub> = 0 V		52		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/μs		84		nC

Note Pulsed

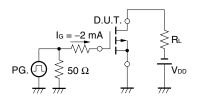
#### **TEST CIRCUIT 1 AVALANCHE CAPABILITY**

# $V_{GS} = -20 \rightarrow 0 \text{ V}$ $V_{DD}$ $V_{DD}$

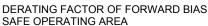
#### TEST CIRCUIT 2 SWITCHING TIME

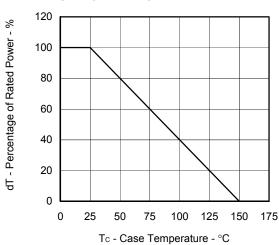


#### **TEST CIRCUIT 3 GATE CHARGE**

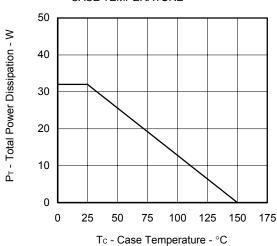


#### TYPICAL CHARACTERISTICS (TA = 25°C)

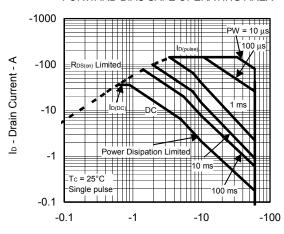




# TOTAL POWER DISSIPATION vs. CASE TEMPERATURE

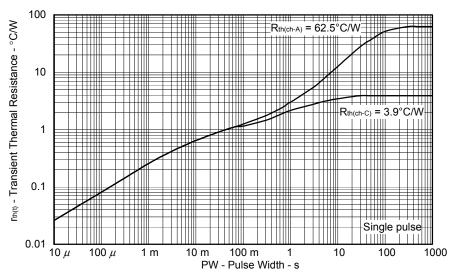


#### FORWARD BIAS SAFE OPERATING AREA



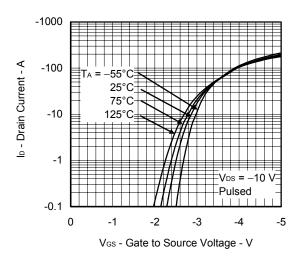
#### $V_{\text{\scriptsize DS}}$ - Drain to Source Voltage - V

#### TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

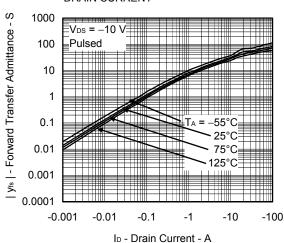


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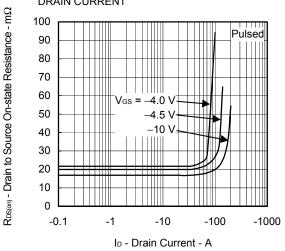
#### FORWARD TRANSFER CHARACTERISTICS



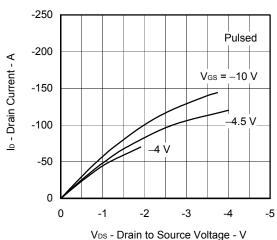
# FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



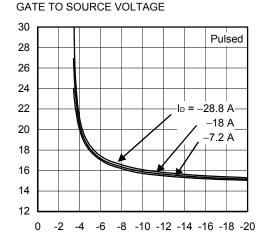
### DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



#### DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE

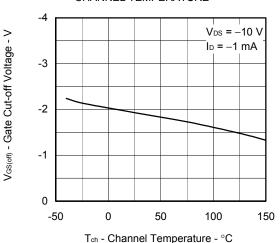


#### DRAIN TO SOURCE ON-STATE RESISTANCE vs.

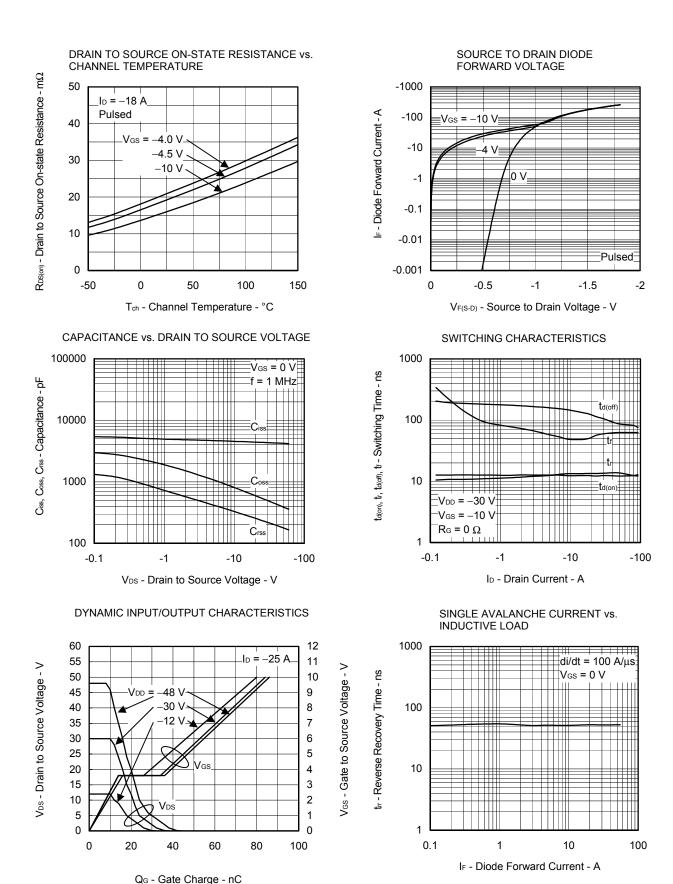


# GATE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE

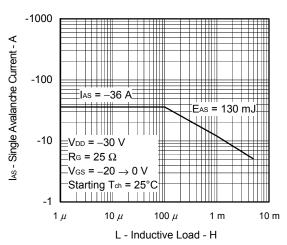
V<sub>GS</sub> - Gate to Source Voltage - V



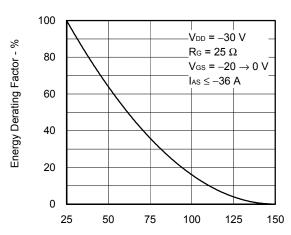
R<sub>DS(m)</sub> - Drain to Source On-state Resistance - mΩ



# SINGLE AVALANCHE CURRENT vs. INDUCTIVE LOAD

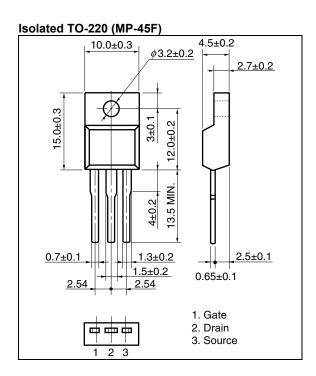


# SINGLE AVALANCHE ENERGY DERATING FACTOR

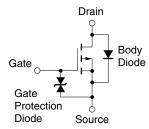


Starting Tch - Starting Channel Temperature - °C

#### PACKAGE DRAWING (Unit: mm)



#### **EQUIVALENT CIRCUIT**



**Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD.

When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this debice.

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